

INFLUENCE OF ADDITIVES ON THE DTA CURVES OF THE SYSTEM CuCl_2 - KCl

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Mixtures of CuCl and KCl containing the additives MgCl_2 , NaCl or CsCl were heated at 473 K in air atmosphere, and then subjected to DTA analysis in the temperature range 293–773 K. The molar ratio of Cu to K in the mixtures varied from 0.5 to 1.0. The influence of the additives on the DTA pictures of the CuCl_2 – KCl system was observed.

DTA analysis of the system CuCl_2 – KCl has been reported [1]. However, the phase changes in the system CuCl_2 – KCl have not been described equivocally. Accordingly, studies of the ethylene oxychlorination mechanism [2–4], the constitution of the liquid phase of the ethylene oxychlorination catalyst [1, 5], and the influence of the carrier on the constitution of the system CuCl_2 – KCl [6, 7] are being continued.

The present work involved thermogravimetric investigations of the system CuCl_2 – KCl (molar ratio of CuCl_2 to KCl from 0.5 to 1.0) containing additives of MgCl_2 , NaCl or CsCl , within the temperature range 293–773 K. It was assumed that these additives would influence the CuCl_2 – KCl phase changes, especially since the CsCl – KCl catalyst [8], catalytic additives of Mg [9] and the negative influence of Na on the catalyst efficiency [10] are known.

Experimental

To prepare the additive-containing CuCl_2 – KCl system, dihydrous copper(II) chloride, potassium chloride, hexahydrous magnesium chloride, sodium chloride, and caesium chloride (POCh, Gliwice) were used.

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Weighed quantities of the salts, in appropriate proportions, were dissolved in distilled water, the solutions were evaporated to dryness and the residues were roasted at 473 K for 2 h in air atmosphere. After cooling down to room temperature, the samples were crushed and ground, and subjected to thermogravimetric analyses. Mixtures with molar ratios of CuCl_2 to KCl of 0.5; 0.614; 0.692; 0.768; 0.845; 0.922 and 1.0 containing 0.5; 1.0, 3.0 and 10% by weight of the additives were prepared as described above.

Thermogravimetric analyses were performed with a derivatograph (MOM, Budapest, Hungary) within the temperature range 293–773 K. The measurement conditions were as follows: constant sample mass 0.600 g, corundum crucible, air atmosphere, Al_2O_3 as reference material, heating rate 5 deg/min, sensitivity DTA 1/5, sensitivity DTG 1/10, and sensitivity TG 200 mg.

Results

Only selected curves are reported here. Common DTG, TG and T curves have been drawn in the Figures to make them more readable, as the lines were almost identical.

Figure 1 shows the endothermic effects in the DTA curves of the investigated samples with MgCl_2 when the molar ratio of Cu to K in the samples was 0.692.

The curves reveal changes in the areas of the endothermic effect, with a minimum at 573–583 K. On increase of the MgCl_2 content of the mixtures, the above endothermic effect also increased. The area of the endothermic effect with minimum at 603–618 K gradually increased. The influence of the MgCl_2 content on the area of the endothermic effect with minimum at 533–543 K was observed.

Figure 2 demonstrates the full disappearance of the endothermic effect with peak at 573–583 K even at 3% MgCl_2 in the mixtures. Increase of the MgCl_2 content up to 10% did not cause changes in the shape and quantity of the endothermic effect with peak at 603–618 K. Also, for instance, the changes were observed in the DTA curves of the mixtures with a Cu to K molar ratio of 0.5 and containing MgCl_2 , and these were compared with those for the mixture of CuCl_2 and KCl alone.

Figure 3 demonstrates the changes in the shape of the endothermic effect with peak at 603–618 K as a result of NaCl addition to the mixtures of CuCl_2 and KCl .

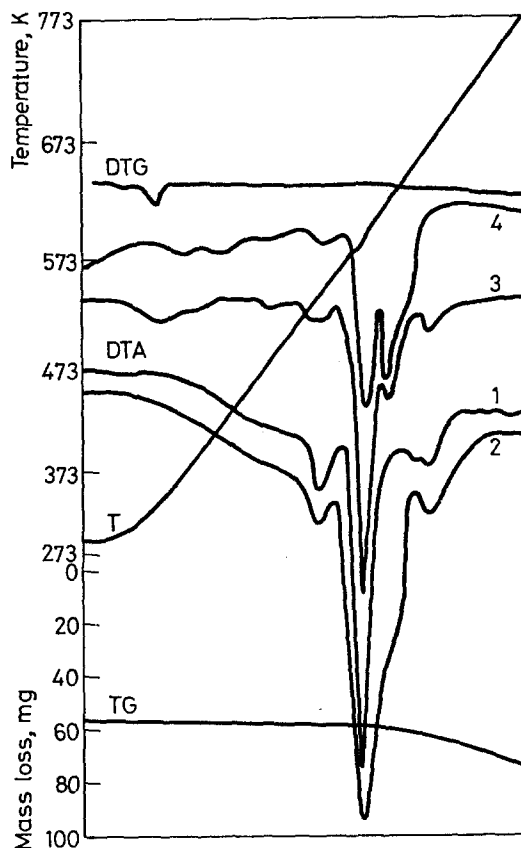


Fig. 1 TG, DTG and DTA curves of a mixture of CuCl_2 and KCl heated at 473 K for 2 h. Molar ratio of Cu to $\text{K} = 0.692$.
 Curve - 1 - mixture of CuCl_2 and KCl ; 2 - mixture of CuCl_2 and KCl with 1% MgCl_2 ;
 3 - mixture of CuCl_2 and KCl with 3% MgCl_2 ; 4 - mixture of CuCl_2 and KCl with 10% MgCl_2

The area of the endothermic effect with peak at 603–618 K gradually decreased to zero on increase of the NaCl content of the mixtures of CuCl_2 and KCl . The changes in the endothermic effects with peak at 573–583 K and with peak at 533–543 K were observed. A similar phenomenon was observed for the mixtures of CuCl_2 and KCl with CsCl (Fig. 4).

In the DTA curves of all analysed mixtures containing the additives MgCl_2 , NaCl or CsCl , all the endothermic effects reported in [1] were observed. New endothermic effects were not detected.

Discussion

The DTA curves of the system $\text{CuCl}_2\text{-KCl}$ with molar ratios of Cu to K of from 0.5 to 1.0 reveal endothermic effects with peaks at 533–543 K, 603–618 K and 673–693 K [1]. The thermogravimetric results presented in this work are quantitatively the same those described in [1]. In the DTA curves, the peaks have identical temperatures to those reported in [1]. The processes recorded in the DTA curves of the mixtures with MgCl_2 , NaCl or CsCl appear to be identical to those observed in [1]. The results obtained here show that the addition of MgCl_2 to the investigated mixtures shifts the DTA picture towards that for higher molar ratios of Cu to K in the mixtures and

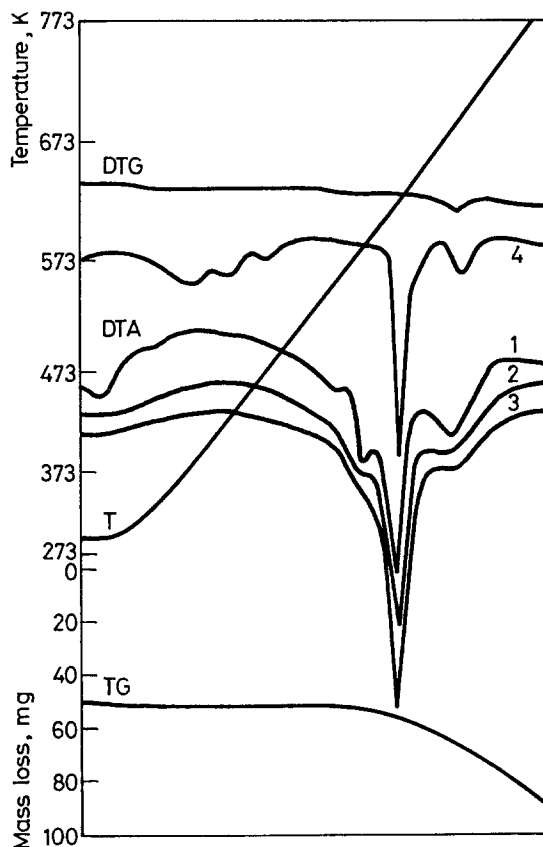


Fig. 2 TG, DTG and DTA curves of a mixture of CuCl_2 and KCl heated at 473 K for 2 h. Molar ratio of Cu to K = 0.922.
 Curve - 1 - mixture of CuCl_2 and KCl ; 2 - mixture of CuCl_2 and KCl with 1% MgCl_2 ; 3 - mixture of CuCl_2 and KCl with 3% MgCl_2 ; 4 - mixture of CuCl_2 and KCl with 10% MgCl_2

does not influence the quantity and quality of the change at 603–618 K (Cu to K = 1.0). These observations together indicate that MgCl_2 stabilizes the combination formed in the 603–618 K change. The addition of NaCl or CsCl to the mixtures of CuCl_2 and KCl shifts the DTA picture towards that for

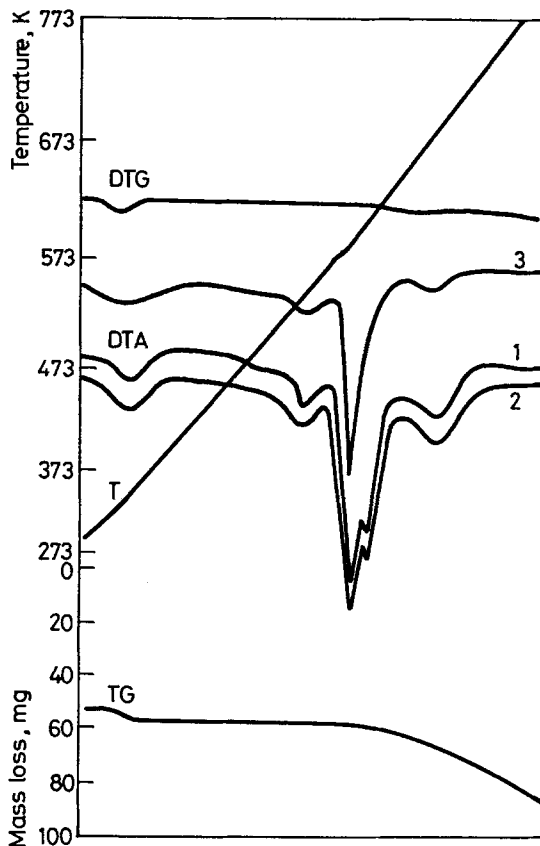


Fig. 3 TG, DTG and DTA curves of a mixture of CuCl_2 and KCl heated at 473 K for 2 h.

Molar ratio of Cu to K = 0.768.

Curve - 1 - mixture of CuCl_2 and KCl; 2 - mixture of CuCl_2 and KCl with 1% NaCl;

3 - mixture of CuCl_2 and KCl with 3% NaCl

smaller molar ratios of Cu to K in the mixtures and does not influence the change at 573–583 K (Cu to K = 0.5). Thus, it may be suggested that NaCl and CsCl destabilize the combination formed in the 603–618 K change or play the same role as KCl in the mixtures of CuCl_2 and KCl. The influences of NaCl and CsCl on the DTA curves of the investigated mixtures appear comparable. Accepting the ionic constitution of CuCl_2 and KCl mixtures [5],

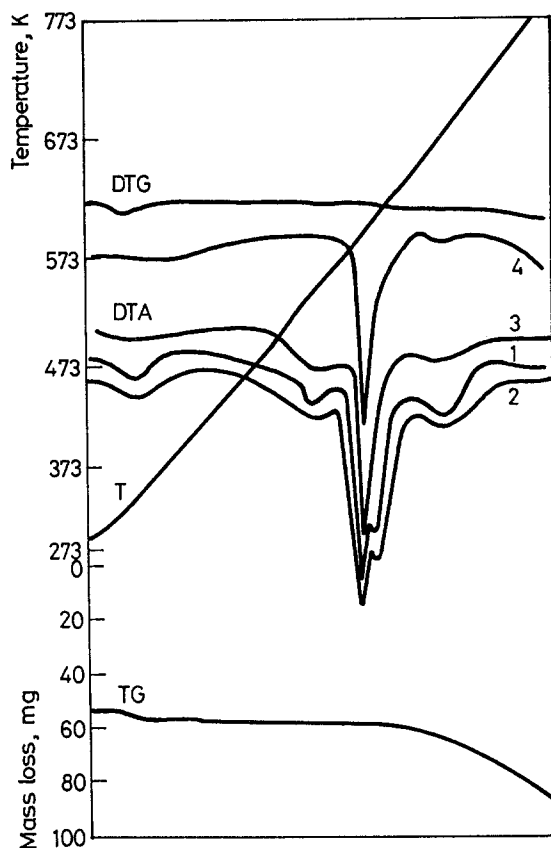


Fig. 4 TG, DTG and DTA curves of a mixture of CuCl_2 and KCl heated at 473 K for 2 h. Molar ratio of Cu to K = 0.768. Curve - 1 - mixture of CuCl_2 and KCl ; 2 - mixture of CuCl_2 and KCl with 1% CsCl ; 3 - mixture of CuCl_2 and KCl with 3% CsCl ; 4 - mixture of CuCl_2 and KCl with 10% CsCl ;

it may be suggested that the differences in the electropositivities of sodium, potassium and caesium are too small to be the reason for the changes in the DTA pictures of the investigated mixtures. It may also support the finding that Na , K , and Cs do not participate in the process of obtaining equilibrium between the ions [5].

Conclusion

The mixtures of CuCl_2 and KCl studied here, containing MgCl_2 , NaCl or CsCl as additives, undergo endothermic processes at 533–543 K, 573–583 K, 603–618 K and 673–693 K. The same processes have been found for the mixtures without MgCl_2 , NaCl and CsCl .

MgCl_2 probably stabilizes the combination formed at 603–618 K in the mixtures of CuCl_2 and KCl .

NaCl and CsCl play the same role as KCl , or destabilize the combination formed at 603–618 K in the investigated mixtures.

The differences in the electropositivities of sodium, potassium and caesium are too small to cause the changes in the DTA pictures of the mixtures investigated here. Equally, sodium, potassium and caesium may not participate in the attainment of equilibrium between the ions.

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Zusammenfassung — Gemische aus CuCl_2 und KCl wurden mit Zusätzen von MgCl_2 , NaCl oder CsCl bei 473 K in Luft erhitzt und dann im Temperaturbereich 293–773 K einer DTA-Untersuchung unterzogen. Das Molverhältnis Cu:K variierte in den Gemischen zwischen 0.5 und 1.0. Es wurde der Einfluß der Zusätze auf den Verlauf der DTA-Kurven des Systemes CuCl_2 - KCl untersucht.